

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1
Stylesheet Version v1.2

EPAS ID: PAT6528902

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
MATTHEW DICKEY BUCHMAN	01/20/2021
YASEMIN UGUR-OZEKINCI	01/21/2021
JAYASHREE B. RADHA	01/20/2021
KENNETH WILLIAM OWENS	01/20/2021
ADRIAN DOBREAN	01/19/2021
KRISHNENDU BAGCHI	01/20/2021
NAVNEET UPADHYAY	01/27/2021
PAWAN SINGH	01/20/2021
RECEIVING PARTY DATA	
Name:	EMC IP HOLDING COMPANY LLC
Street Address:	176 SOUTH STREET
City:	HOPKINTON
State/Country:	MASSACHUSETTS
Postal Code:	01748
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	17160365
CORRESPONDENCE DATA	
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<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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ATTORNEY DOCKET NUMBER:	170360-071400US
NAME OF SUBMITTER:	JESSICA STRYKER
SIGNATURE:	/Jessica Stryker/

PATENT

DATE SIGNED:	02/01/2021
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Total Attachments: 10
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ASSIGNMENT

WHEREAS, we, Matthew Dickey Buchman, Yasemin Ugur-Ozekinci, Jayashree B. Radha, Kenneth William Owens, Adrian Dobrea, Krishnendu Bagchi, Navneet Upadhyay, and Pawan Singh have invented an invention comprising and/or embodying certain improvements or discoveries or both as described in an application for Letters Patent of the United States entitled *METHOD AND SYSTEM FOR PERFORMING DATA PROTECTION MANAGEMENT USING AN ADD-ON APPLICATION PROGRAMMING INTERFACE*, the specification of which:

is being executed on even date herewith and is about to be filed in the United States Patent Office;

was filed on _____ as U.S. Application No. _____;

was patented under U.S. Patent No. _____ on _____.

WHEREAS, EMC IP Holding Company LLC (hereinafter "ASSIGNEE"), a corporation organized and existing under the laws of the Commonwealth of Massachusetts and having a usual place of business at 176 South Street, Hopkinton, Massachusetts 01748 desires to acquire an interest therein in accordance with agreements duly entered into with us;

NOW, THEREFORE, to all whom it may concern be it known that for and in consideration of said agreements and of other good and valuable consideration, the receipt of which is hereby acknowledged, we have sold, assigned and transferred and by these presents do hereby sell, assign and transfer unto said ASSIGNEE, its successors, assigns and legal representatives, the entire right, title and interest in and throughout the United States of America, its territories and all foreign countries, in and to said invention as described in said application, together with the entire right, title and interest in and to said application and such Letters Patent as may issue thereon; said invention, application and Letters Patent to be held and enjoyed by said ASSIGNEE for its own use and behalf and for its successors, assigns and legal representatives, to the full end of the term for which said Letters Patent may be granted as fully and entirely as the same would have been held by us had this assignment and sale not been made; we hereby convey to ASSIGNEE all rights arising under or pursuant to any and all international agreements, treaties or laws relating to the protection of industrial property by filing any such applications for Letters Patent. We hereby acknowledge that this assignment, being of the entire right, title and interest in and to said invention, carries with it the right in ASSIGNEE to apply for and obtain from competent authorities in all countries of the world any and all Letters Patent by attorneys and agents of ASSIGNEE's selection and the right to procure the grant of all such Letters Patent to ASSIGNEE for its own name as assignee of the entire right, title and interest therein;

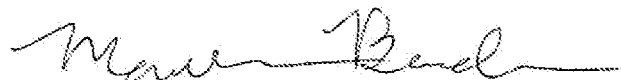
AND, we hereby further agree for ourselves and our executors and administrators to execute upon request any other lawful documents and likewise to perform any other lawful acts which may be deemed necessary to secure fully the aforesaid invention to said ASSIGNEE, its successors, assigns and legal representatives, but at its or their expense and charges, including the execution of applications for patents in foreign countries, and the execution of substitution, reissue, divisional or continuation applications and preliminary or other statements and the

giving of testimony in any interference or other proceeding in which said invention or any application or patent directed thereto may be involved;

AND, we do hereby authorize and request the Commissioner of Patents of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said ASSIGNEE, its successors, assigns, and legal representatives.

IN TESTIMONY WHEREOF, we have hereunto set our hands and affixed our seals as set forth below:

Date: Jan 20, 2021



Inventor's Signature

Print full name of first inventor:

Matthew Dickey Buchman

Residence:

Seattle, WA

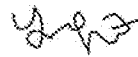
Citizenship:

U.S.

Mailing Address:

c/o EMC IP Holding Company LLC
176 South Street
Hopkinton, MA 01748

Date: 01/21/201



Inventor's Signature

Print full name of second inventor:

Yasemin Ugur-Ozekinci

Residence:

Oakville, ON

Citizenship:

Canada

Mailing Address:

c/o EMC IP Holding Company LLC
176 South Street
Hopkinton, MA 01748

Date:

01/20/2021

Jayashree Radha

Inventor's Signature

Print full name of third inventor:

Jayashree B. Radha

Residence:

Bangalore, KA

Citizenship:

India

Mailing Address:

c/o EMC IP Holding Company LLC
176 South Street
Hopkinton, MA 01748

Date: Jan 20, 2011

Ken Owens
Inventor's Signature

Print full name of fourth inventor:

Kenneth William Owens

Residence:

Burlington, ON

Citizenship:

Canada

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Date: 2021, Jan 19



Inventor's Signature

Print full name of fifth inventor:

Adrian Dobrea

Residence:

Oakville, ON

Citizenship:

Canada

Mailing Address:

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Date: 01.20.2021



Inventor's Signature

Print full name of sixth inventor:

Krishuendu Bagchi

Residence:

Bangalore, IN

Citizenship:

India

Mailing Address:

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176 South Street
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Date: 01/27/2021

Nayneet

.....
Inventor's Signature

Print full name of seventh inventor:

Nayneet Upadhyay

Residence:

Ghaziabad, UP

Citizenship:

India

Mailing Address:

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Date: 20th Jan 2021

Pawan Singh
Inventor's Signature

Print full name of eighth inventor:

Pawan Singh

Residence:

Bangalore, KA

Citizenship:

India

Mailing Address:

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Hopkinton, MA 01748